IN THE UNITED STATES PATENT AND TRADEMARK OFFICE.

Applicants Appl. No. :Masaru SHIRAI et al.

Group Art Unit: 1793

: 10/598,142

Examiner: Nicholas P D'ANIELLO

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For

: HEATER, REFLOW APPARATUS, AND SOLDER BUMP FORMING METHOD AND APPARATUS

AMENDMENT UNDER 37 C.F.R. § 1.116

Commissioner for Patents U.S. Patent and Trademark Office Customer Service Window, Mail Stop Amendment Randolph Building 401 Dulany Street Alexandria, VA 22314

Sir

This is in response to the Final Office Action mailed October 13, 2009. Inasmuch as the three-month shortened statutory period is originally set in the Office Action to expire on January 13, 2010, this paper is timely filed. However, if the Office deems an Extension of Time necessary, the same is hereby requested, and the undersigned authorizes the Office to charge any requisite fee due for consideration of this Response to Deposit Account No. 19-0089.

Applicants respectfully request reconsideration and withdrawal of the rejections in view of the amendments and remarks which follow:

Amendments to the Claims are reflected in the Listing of Claims, beginning on page 2 of this paper.

Remarks begin on page 8 of this paper.